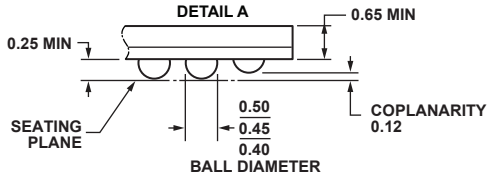
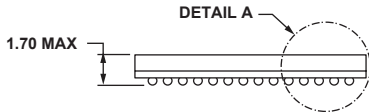
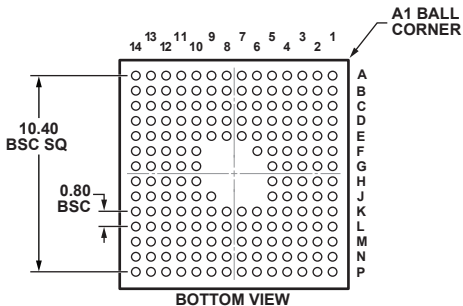
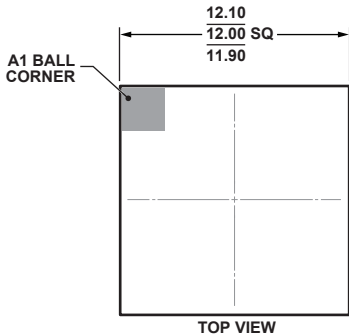


182-Ball Chip Scale Package Ball Grid Array [CSP_BGA] (BC-182)

Dimensions shown in millimeters



COMPLIANT WITH JEDEC STANDARDS MO-275-GGAA-1.